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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

February 2015

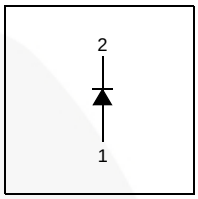
BAS70SL
Schottky Barrier Diode

Features

- Low Forward Voltage Drop
- Fast Switching
- Very Small and Thin SMD package
- Profile Height, 0.43 mm Maximum
- Footprint, 1.0 mm x 0.6 mm

SOD-923F
Marking: AC

Connection Diagram



Ordering Information

Part Number	Top Mark	Package	Packing Method
BAS70SL	AC	SOD-923F 2L	Tape and Reel

Absolute Maximum Ratings(1), (2)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Value	Unit
V_{RRM}	Maximum Repetitive Reverse Voltage	70	V
$I_{F(AV)}$	Average Rectified Forward Current	70	mA
I_{FSM}	Forward Surge Current (8.3 ms Single Half-Sine-Wave)	100	mA
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 to +150	°C

Notes:

1. These ratings are based on a maximum junction temperature of 150°C.
2. These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty-cycle operations.

Thermal Characteristics

Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Value	Unit
P_D	Power Dissipation	227	mW
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient(3)	550	°C/W

Note:

3. Minimum land pad.

Electrical Characteristics

Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Max.	Unit
V_R	Breakdown Voltage	I_R = 100 µA	70		V
V_F	Forward Voltage	I_F = 1 mA		410	mV
		I_F = 15 mA		1000	mV
I_R	Reverse Leakage	V_R = 50 V		0.2	µA
t_{rr}	Reverse Recovery Time	$I_F = I_R$ = 10 mA, $i_{rr} = 0.1I_R$		8.0	nS
C_J	Junction Capacitance	V_R = 0, f = 1.0 MHz		3.0	pF

Typical Performance Characteristics

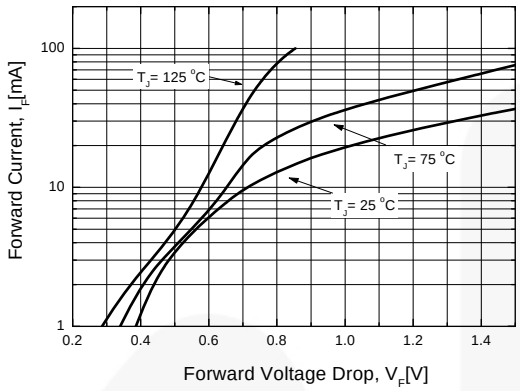


Figure 1. Forward Current Characteristics

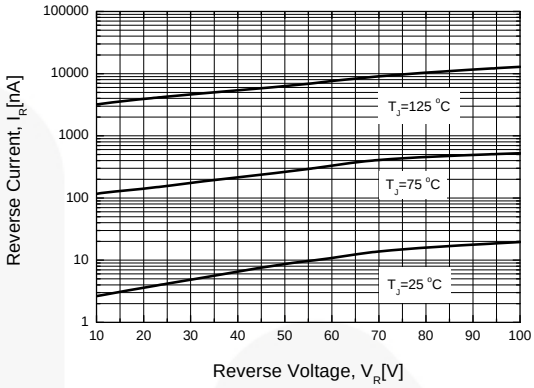


Figure 2. Reverse Leakage Current

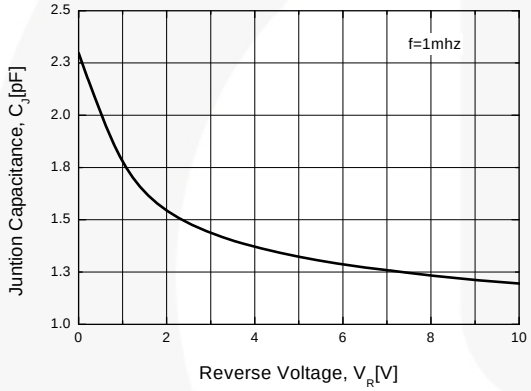


Figure 3. Junction Capacitance

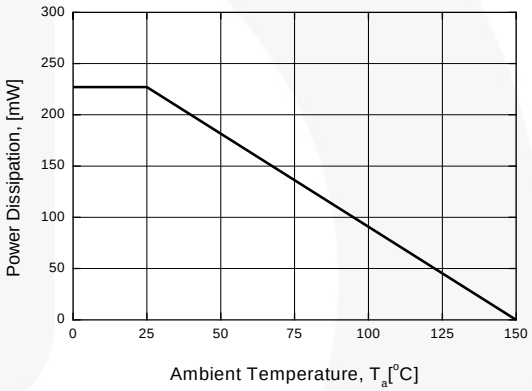
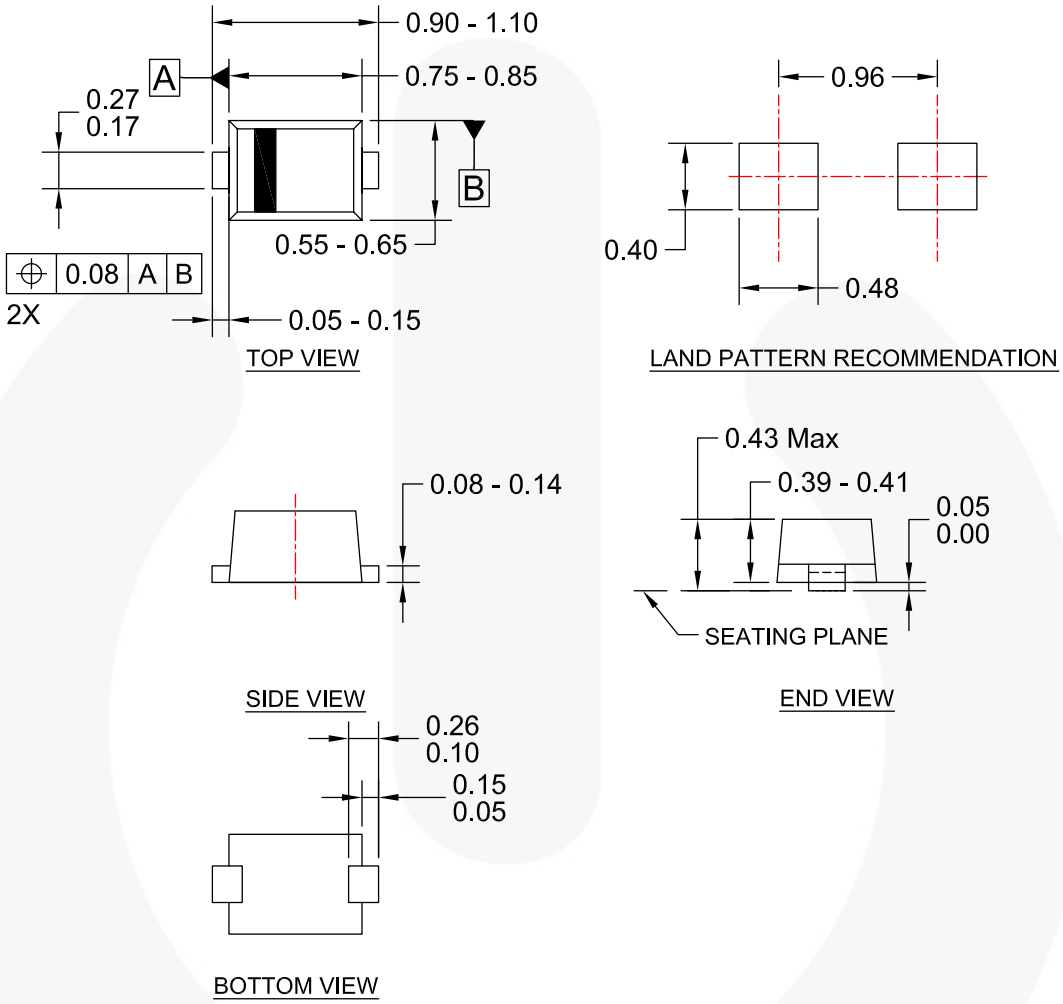


Figure 4. Power Derating

Physical Dimensions



NOTES:
A) THIS PACKAGE DOES NOT COMPLY
TO ANY CURRENT PACKAGING STANDARD.
B) ALL DIMENSIONS ARE IN MILLIMETERS.
C) BODY DIMENSIONS ARE INCLUSIVE OF BURRS, AND MOLD FLASH.
D) DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009
E) LANDPATTERN BASED ON ADJUSTED IPC GUIDELINES
F) DRAWING FILE NAME : SOD923F1REV3

Figure 5. 2-LEAD, SOD923F, 0.4 mm TALL, FLAT TERMINAL

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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

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